

> Features

- High Speed Switching
- Low On-Resistance
- No Secondary Breakdown
- Low Driving Power
- High Voltage
- $V_{GS} = \pm 30V$ Guarantee
- Avalanche Proof

> Applications

- Switching Regulators
- UPS
- DC-DC converters
- General Purpose Power Amplifier

> Maximum Ratings and Characteristics

- Absolute Maximum Ratings (Tc=25°C), unless otherwise specified

Item	Symbol	Rating	Unit
Drain-Source-Voltage	V_{DS}	250	V
Drain-Gate-Voltage ($R_{GS}=20K\Omega$)	V_{DGR}	250	V
Continuous Drain Current	I_D	2	A
Pulsed Drain Current	$I_{D(puls)}$	8	A
Gate-Source-Voltage	V_{GS}	± 30	V
Max. Power Dissipation	P_D	20	W
Operating and Storage Temperature Range	T_{ch}	150	$^{\circ}C$
	T_{sta}	-55 ~ +150	$^{\circ}C$

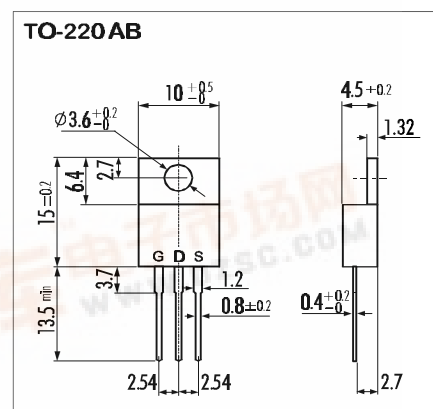
- Electrical Characteristics (T_C=25°C), unless otherwise specified

Item	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Drain-Source Breakdown-Voltage	$V_{(BR)DSS}$	$I_D=1mA$ $V_{GS}=0V$	250			V
Gate Threshold Voltage	$V_{GS(th)}$	$I_D=1mA$ $V_{DS}=V_{GS}$	2,5	3,0	3,5	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=250V$ $T_{ch}=25^{\circ}C$		10	500	μA
		$V_{GS}=0V$ $T_{ch}=125^{\circ}C$		0,2	1,0	mA
Gate Source Leakage Current	I_{GSS}	$V_{GS}=\pm 30V$ $V_{DS}=0V$		10	100	nA
Drain Source On-State Resistance	$R_{DS(on)}$	$I_D=1A$ $V_{GS}=10V$		1,2	2,0	Ω
Forward Transconductance	g_{fs}	$I_D=1A$ $V_{DS}=25V$	0,7	1,5		S
Input Capacitance	C_{iss}	$V_{DS}=25V$ $V_{GS}=0V$ $f=1MHz$		250	380	pF
Output Capacitance	C_{oss}			50	80	pF
Reverse Transfer Capacitance	C_{rss}			15	25	pF
Turn-On-Time t_{on} ($t_{on}=t_{d(on)}+t_r$)	$t_{d(on)}$	$V_{CC}=150V$ $I_D=2A$		25	40	ns
	t_r			20	30	ns
Turn-Off-Time t_{off} ($t_{on}=t_{d(off)}+t_f$)	$t_{d(off)}$	$V_{GS}=10V$		50	80	ns
	t_f	$R_{GS}=10\Omega$		15	25	ns
Avalanche Capability	I_{AV}	$L = 100\mu H$ $T_{ch}=25^{\circ}C$	2			A
Continous Reverse Drain Current	I_{DR}				2	A
Pulsed Reverse Drain Current	I_{DRM}				4	A
Diode Forward On-Voltage	V_{SD}	$I_F=2xI_{DR}$ $V_{GS}=0V$ $T_{ch}=25^{\circ}C$		0,9	1,4	V
Reverse Recovery Time	t_{rr}	$I_F=I_{DR}$ $V_{GS}=0V$		80		ns
Reverse Recovery Charge	Q_{rr}	$-di_F/dt=100A/\mu s$ $T_{ch}=25^{\circ}C$		0,2		μC

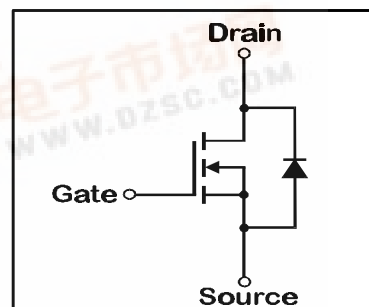
- Thermal Characteristics

Item	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Thermal Resistance	$R_{th(ch-a)}$	channel to air			75	°C/W
	$R_{th(ch-c)}$	channel to case			6,25	°C/W

> Outline Drawing



> Equivalent Circuit



N-channel MOS-FET			
250V	2Ω	2A	20W

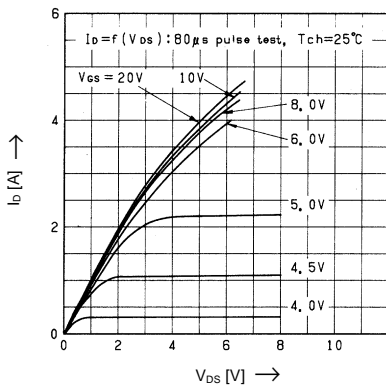
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FAP-IIA Series

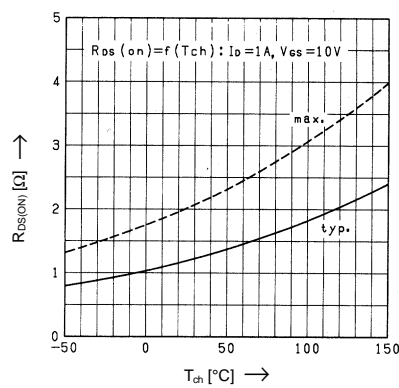
FUJI
ELECTRIC

> Characteristics

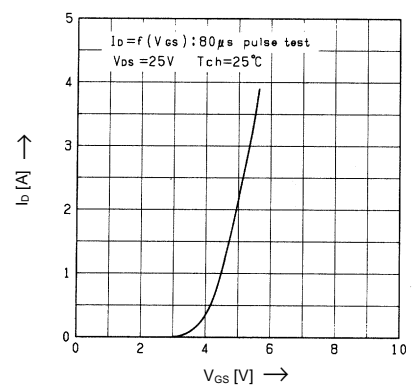
Typical Output Characteristics



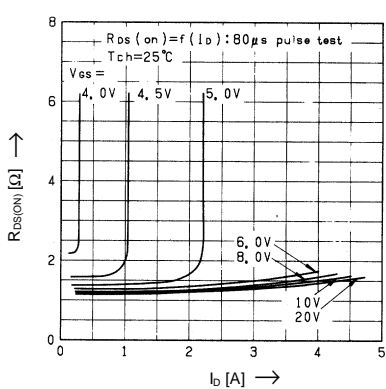
Drain-Source-On-State Resistance vs. T_{ch}



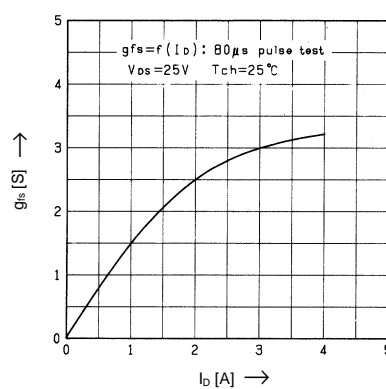
Typical Transfer Characteristics



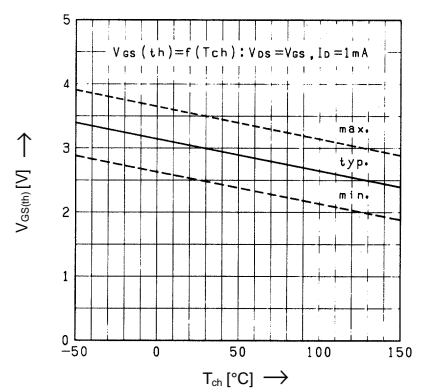
Typical Drain-Source-On-State-Resistance vs. I_D



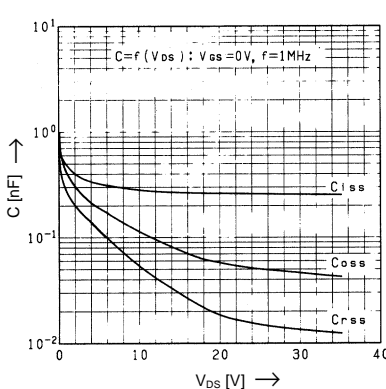
Typical Forward Transconductance vs. I_D



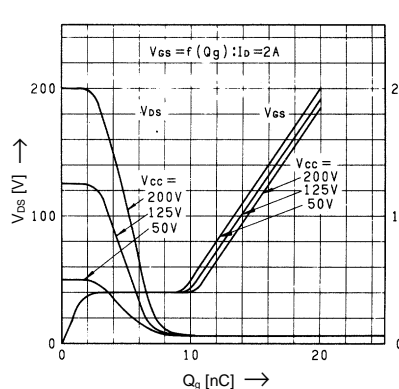
Gate Threshold Voltage vs. T_{ch}



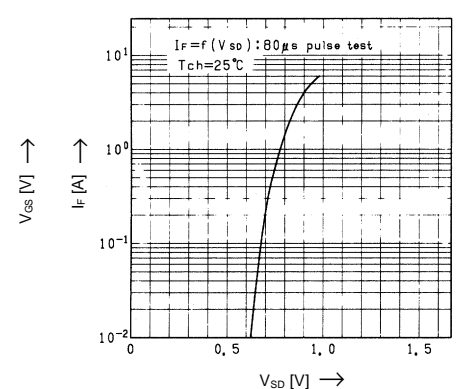
Typical Capacitance vs. V_{DS}



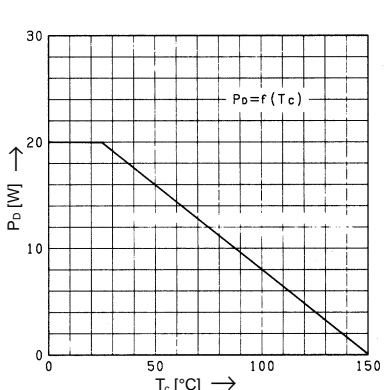
Typical Input Charge



Forward Characteristics of Reverse Diode



Allowable Power Dissipation vs. T_C



Safe operation area

